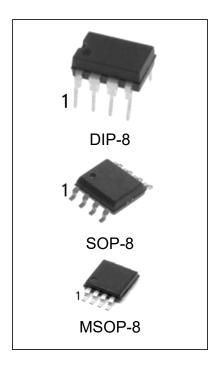


#### **Feature**

- Fail-safe circuitry
- Low power consumption
- Up to 128 transceivers can be attached to the bus
- Maximum transmission rate: 10Mbps
- ESD: ≥ ±15kV
- DIP-8,SOP-8,MSOP-8, Package

### **Applications**

- RS-485 Communications
- Level Translators
- Security Equipment
- Industrial Control Equipment
- Watt-hour meter



## **Ordering Information**

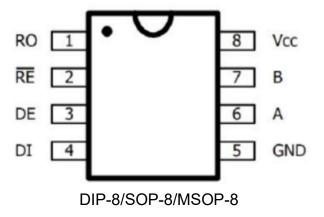
DEVICE	Package Type	MARKING	Packing	Packing Qty
SN65176BPG	DIP-8	65176B	TUBE	2000pcs/reel
SN65176BDRG	SOP-8	65176B	REEL	2500pcs/reel
SN65176BDGKRG	MSOP-8	65176B	REEL	3000pcs/reel
SN75176BPG	DIP-8	75176B	TUBE	2000pcs/reel
SN75176BDRG	SOP-8	75176B	REEL	2500pcs/reel
SN75176BDGKRG	MSOP-8	75176B	REEL	3000pcs/reel



### **General Description**

The SN65176B/75176B is high-speed transceivers for RS-485 communication, which contain one driver and one receiver. The SN65176B/75176B feature fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted. This means that the receiver output will be a logic high if all transmitters on a terminated bus are disabled (high impedance). The SN65176B/75176B driver slew rates are not limited, making transmit speeds up to 10Mbps possible.. And this device has a 1/8-unit-load receiver input impedance that allows up to 128 transceivers on the bus.

### **Pin Assignment**

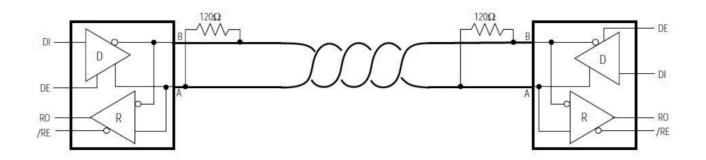


### **Pin Description**

PIN	NAME	FUNCTION
1	RO	Receiver Output, When RE is low and if A - B $\geq$ -50mV, RO will be high; if A - B $\leq$ -200mV, RO will below.
2	/RE	Receiver Output Enable. Drive RE low to enable RO; RO is high impedance when RE is high. Drive RE high and DE low to enter low-power shutdown mode.
3	DE	Driver Output Enable. Drive DE high to enable driver outputs. These outputs are high impedance when DE is low. Drive RE high and DE low to enter low-power shutdown mode.
4	DI	Driver Input. With DE high, a low on DI forces noninverting output low and inverting output high.
5	GND	Ground
6	Α	Noninverting Receiver Input and Noninverting Driver Output
7	В	Inverting Receiver Input and Inverting Driver Output
8	VCC	Positive Supply



## Typical application circuit



## **Absolute Maximum Ratings** (TA=25°C)

PARAMETER		MIN	MAX	UNITS
Supply Voltage (V <sub>CC</sub> )		-	+7V	V
Control Input Voltage (/RE, DE)		-0.3	Vcc+0.3V	V
Driver Input Voltage (DI)		-0.3	Vcc+0.3V	V
Driver Output Voltage (A,B)		-13V	+13V	V
Receiver Input Voltage (A,B)		-13V	+13V	V
Receiver Output Voltage (R <sub>O</sub> )		-0.3	Vcc+0.3V	V
	SN75176B	0	+70	$^{\circ}$
Operating Temperature (T <sub>OPR</sub> )	SN65176B	-40	+85	$^{\circ}$
Storage Temperature (T <sub>STG</sub> )	-65	+150	$^{\circ}$	
Lead Temperature (Soldering, 10 s	-	+245	${\mathbb C}$	

Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured.



#### DC ELECTRICAL CHARACTERISTICS (VCC=5V, TA=25°C) (1)

PARAMETER	SYMBOL	COI	NDITIONS	MIN	ТҮР	MAX	UNITS
Differential Driver Output (no load)	V <sub>OD1</sub>			-	-	VCC	V
Differential Driver Output	V <sub>OD2</sub>			1.8	-	-	V
Change in Magnitude of Differential Output Voltage	$\Delta V_OD$	R=27	Ώ, Figure 1	-	-	0.2	V
Driver Common-Mode Output Voltage	Voc			1.0	-	3.0	V
Change in Magnitude of Common-Mode Voltage (2)	ΔV <sub>OC</sub>			-	-	0.2	V
Input High Voltage	V <sub>IH</sub>	DE	E, DI, /RE	2.0	ı	•	V
Input Low Voltage	V <sub>IL</sub>	DE	E, DI, /RE	-	ı	0.8	V
DI Input Hysteresis	V <sub>HYS</sub>	-		-	100	-	mV
Driver Innet Comment (A And D)	I <sub>IN1</sub>	VIN=12V	DE=0V,	-	-	150	uA
Driver Input Current (A And B)		VIN=-7V	Vcc=0V/5.25V	-150	-	-	uA
Driver Short-Circuit Output Current (3)	I <sub>OSD</sub>	A and E	3 Short-Circuit	-100	-	100	mA
Receiver Differential Threshold Voltage	V <sub>TH</sub>	-7V	≤V <sub>CM</sub> ≤12V	-200	-125	-50	mV
Receiver Input Hysteresis	$\triangle V_{TH}$		-	-	40	-	mV
Receiver Output High Voltage	V <sub>OH</sub>	IO=-4m	A, V <sub>ID</sub> =-50mV	VCC-1	-	-	V
Receiver Output Low Voltage	V <sub>OL</sub>	IO=4mA	A, V <sub>ID</sub> =-200mV	-	ı	0.4	V
Three-State Output Current at Receiver	l <sub>ozr</sub>	0.4\	/≤Vo≤2.4V	-	-	±1	μA
Receiver Input Resistance	R <sub>IN</sub>	-7V≤V <sub>CM</sub> ≤12V		96	-	-	ΚΩ
Receiver Output Short -Circuit Current	I <sub>OSR</sub>	0V≤V <sub>RO</sub> ≤VCC		±7	-	±100	mA
Complete Company		DE=VCC No Load DE=GND /RE=DI=VCC/GND		-	450	900	μA
Supply Current	I <sub>CC</sub>			-	450	600	μA
Supply Current in Shutdown Mode	I <sub>SHDN</sub>		ID, /RE=VCC, VCC/GND	-	-	10	μA

Note 1: All currents into the device are positive; all currents out of the device are negative. All voltages are referred to device ground unless otherwise noted.

Note 2:  $\Delta V_{OD}$  and  $\Delta V_{OC}$  are the changes in  $V_{OD}$  and  $V_{OC}$ , respectively, when the DI input changes state.

Note 3: Maximum current level applies to peak current just prior to foldback-current limiting; minimum current level applies during current limiting.



## Switching Characteristics (VCC=5V, TA=25°C)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
District Control	t <sub>DPLH</sub>		-	30	60	ns
Driver Input to Output	t <sub>DPHL</sub>	Fig 2 and 5 D 540	-	30	60	ns
Driver Output Skew   TDPLH - TDPHL	t <sub>DSKEW</sub>	Figure 3 and 5, $R_{DIFF}$ =54 $\Omega$ $C_{L1}$ = $C_{L2}$ =100pF	-	-	20	ns
Driver Rise or Fall Time	$t_{DR}$ , $t_{DF}$		-	30		ns
Maximum Data Rate	$F_MAX$	-	10	-	-	Mbps
Driver Enable to Output High	$t_{DZH}$	Figure 4 and 6,	-	-	70	ns
Driver Disable Time from High	$t_{DHZ}$	C <sub>L</sub> =100pF S2 closed	-	-	70	ns
Driver Enable to Output Low	t <sub>DZL</sub>	Figure 4 and 6,	-	-	70	ns
Driver Disable Time from Low	t <sub>DLZ</sub>	C <sub>L</sub> =100pF S1 closed	-	-	70	ns
Receiver Input to Output	t <sub>RPLH</sub>	Figure 7 and 9, $ V_{ID}  \ge 2.0V$ , rise and fall	-	90	250	ns
T <sub>RPLH</sub> -T <sub>RPHL</sub>   Differential Receiver Skew	t <sub>RSKD</sub>	time of V <sub>ID</sub> ≦15ns	-	30	-	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	Figure 2 and 8,	-	30	70	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	C <sub>RL</sub> =15pF S1 closed	-	30	70	ns
Receiver Enable to Output High	$t_{RZH}$	Figure 2 and 8,	-	30	70	ns
Receiver Disable Time from High	t <sub>RHZ</sub>	C <sub>RL</sub> =15pF S2 closed	-	30	70	ns
Time to Shutdown	t <sub>SHDN</sub>	-	-	200	600	ns



#### **Function Tables**

### **Transmitting**

	INPUTS	OUTI	PUTS		
/RE	DE	DI	Α	В	
X	1	1	1	0	
X	1	0	0	1	
0	0	X	High-Z	High-Z	
1	0	X	Shutdown		

### Receiving

	INPUTS				
/RE	DE	A-B	RO		
0	X	≥-0.05V	1		
0	X	≤-0.2V	0		
0	X	Open/shorted	1		
1	1	X	High-Z		
1	0	X	Shutdown		

#### **Test circuit**

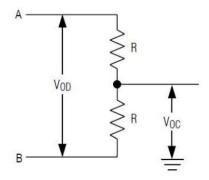


Figure 1. Driver DC Test Load

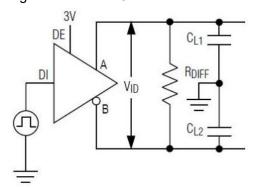


Figure 3. Driver Timing Test Circuit

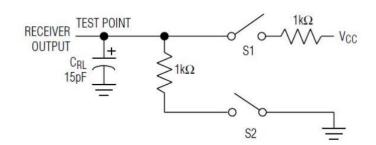


Figure 2. Receiver Enable/Disable Timing Test Load

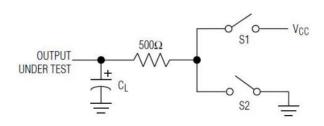


Figure 4. Driver Enable/Disable Timing Test Load



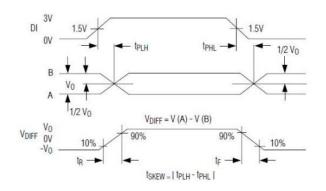


Figure 5. Driver Propagation Delays

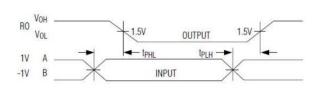


Figure 7. Receiver Propagation Delays

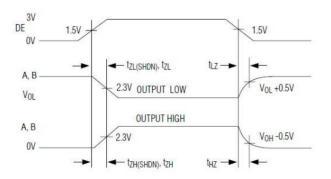


Figure 6. Driver Enable and Disable Times

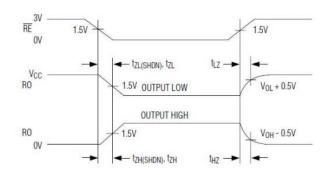
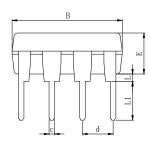


Figure 8. Receiver Enable and Disable Times

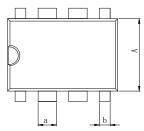


# **Physical Dimensions**

### DIP-8

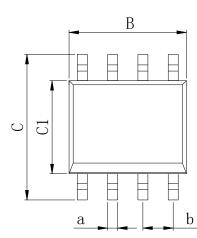


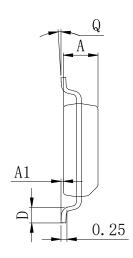




Dimensions In Millimeters(DIP-8)												
Symbol:	Α	В	D	D1	Е	L	L1	а	b	С	d	
Min:	6.10	9.00	8.10	7.42	3.10	0.50	3.00	1.50	0.85	0.40	2.54.BSC	
Max:	6.68	9.50	10.9	7.82	3.55	0.70	3.60	1.55	0.90	0.50	2.54 BSC	

SOP-8  $_{(150mil)}$ 



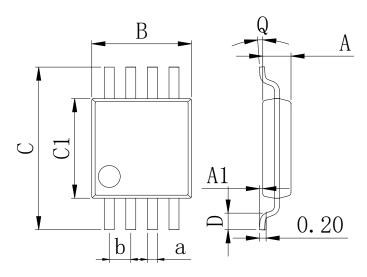


Dimensions In Millimeters(SOP-8)											
Symbol:	Α	A1	В	С	C1	D	Ø	а	р		
Min:	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1 27 DSC		
Max:	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	1.27 BSC		



# **Physical Dimensions**

### MSOP-8



Dimensions In Millimeters(MSOP-8)												
Symbol:	Α	A1	В	С	C1	D	Q	а	b			
Min:	0.80	0.05	2.90	4.75	2.90	0.35	0°	0.25	0.65.000			
Max:	0.90	0.20	3.10	5.05	3.10	0.75	8°	0.35	0.65 BSC			



# **Revision History**

DATE	REVISION	PAGE
2014-1-5	New	1-11
2024-1-2	Document Reformatting	1-11





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